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Atty. Docket No. CPAC 1017-3
Appl. No. 10/632,568

MAY 16 2005

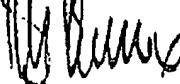
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos)
Application No.: 10/632,568) Examiner: Douglas M. Menz
Filed: Month Day, 2004) Group Art Unit: 2824
Title: Semiconductor multi-package module) Date: May 16, 2005
having package stacked over ball grid array)
package and having wire bond interconnect))
between stacked packages)
CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to
Examiner Menz in the United States Patent and Trademark Office, at the Central
Fax no. 703 872-9306 on May 16, 2005.

Signed


Bill Kennedy

COMMISSIONER FOR PATENTS
P.O BOX 1450
ALEXANDRIA, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office action mailed December 15, 2004, kindly amend the application
as follows.

Amendments to the claims are reflected in the Listing of Claims, which begins on page 2 of this
paper.

Remarks begin on page 6 of this paper.

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